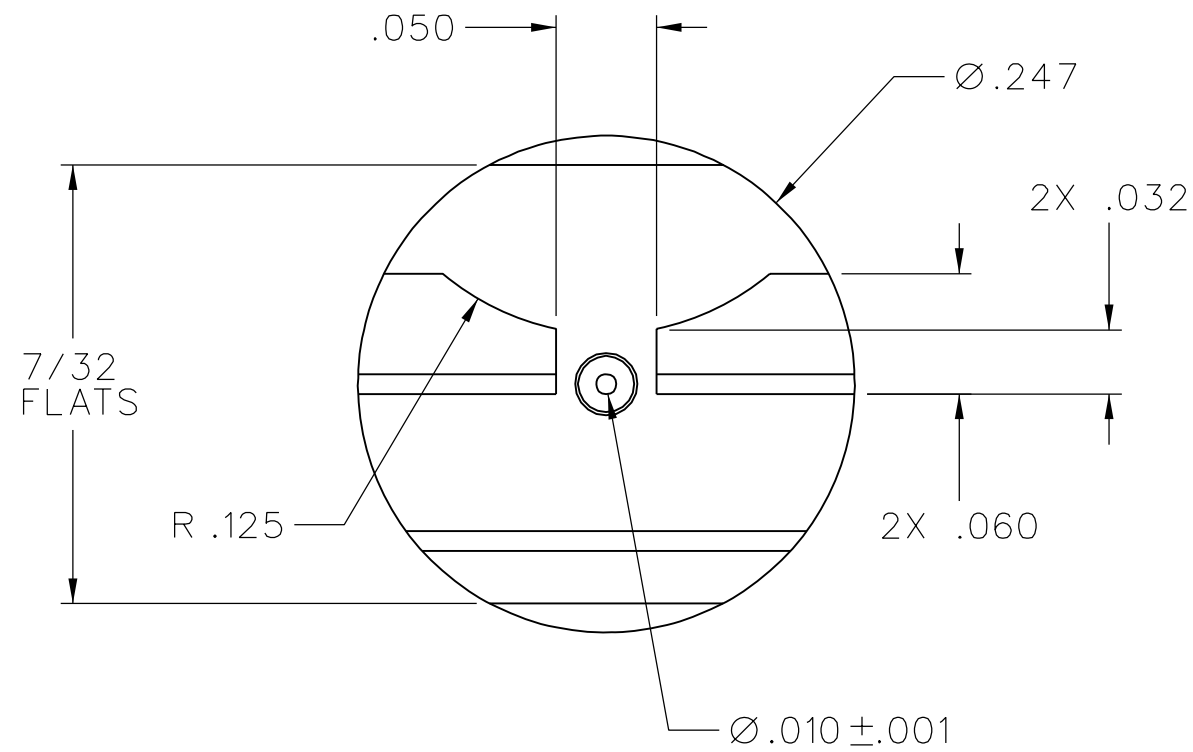


PART NUMBER	ITEM ① BODY	ITEM ② CONTACT	ITEM ③ INSULATOR
142-0761-891	BRASS GOLD PL .00001 MIN OVER NICKEL PL .0001 MIN OVER COPPER PL .00005 MIN	BERYLLIUM COPPER GOLD PL .00005 MIN OVER NICKEL PL .00005 MIN OVER COPPER PL .00005 MIN	TEFLON



NOTES:

1. SPECIFICATIONS:

IMPEDANCE: 50 OHMS
FREQUENCY RANGE: 0-26.5 GHz
VSWR: 1.05+.02F(GHz) MAX AT 0-18 GHz
WORKING VOLTAGE: 170 VRMS MAX AT SEA LEVEL
DIELECTRIC WITHSTANDING VOLTAGE: 500 VRMS MIN AT SEA LEVEL
INSULATION RESISTANCE: 1000 MEGOHM MIN
CONTACT RESISTANCE:
 CENTER CONTACT - INITIAL 3.0 MILLIOHM MAX, AFTER ENVIRONMENTAL 4.0 MILLIOHM MAX
 OUTER CONDUCTOR - INITIAL 2.0 MILLIOHM MAX AFTER ENVIRONMENTAL NOT APPLICABLE
CORONA LEVEL: 125 VOLTS MIN AT 70,000 FEET
INSERTION LOSS: NOT APPLICABLE (DEPENDANT UPON APPLICATION)
RF LEAKAGE: NOT APPLICABLE
RF HIGH POTENTIAL WITHSTANDING VOLTAGE: 335 VRMS MIN AT 4 AND 7 MHz

MECHANICAL:

ENGAGE/DISENGAGE TORQUE: 2 INCH-POUNDS MAX
MATING TORQUE: 7-10 INCH POUNDS
CONTACT RETENTION: 6 LBS MIN AXIAL FORCE ON MATING END
 4 IN-OZ MIN RADIAL TORQUE
DURABILITY: 500 CYCLES MIN

ENVIRONMENTAL:

(MEETS OR EXCEEDS THE APPLICABLE PARAGRAPH OF MIL-PRF-39012)
THERMAL SHOCK: MIL-STD-202, METHOD 107, CONDITION B, EXCEPT 115°C HIGH TEMP
OPERATING TEMPERATURE: -65 DEG C TO 165 DEG C
CORROSION: MIL-STD-202, METHOD 101, CONDITION B
SHOCK: MIL-STD-202, METHOD 213, CONDITION I
VIBRATION: MIL-STD-202, METHOD 204, CONDITION D
MOISTURE RESISTANCE: MIL-STD-202, METHOD 106

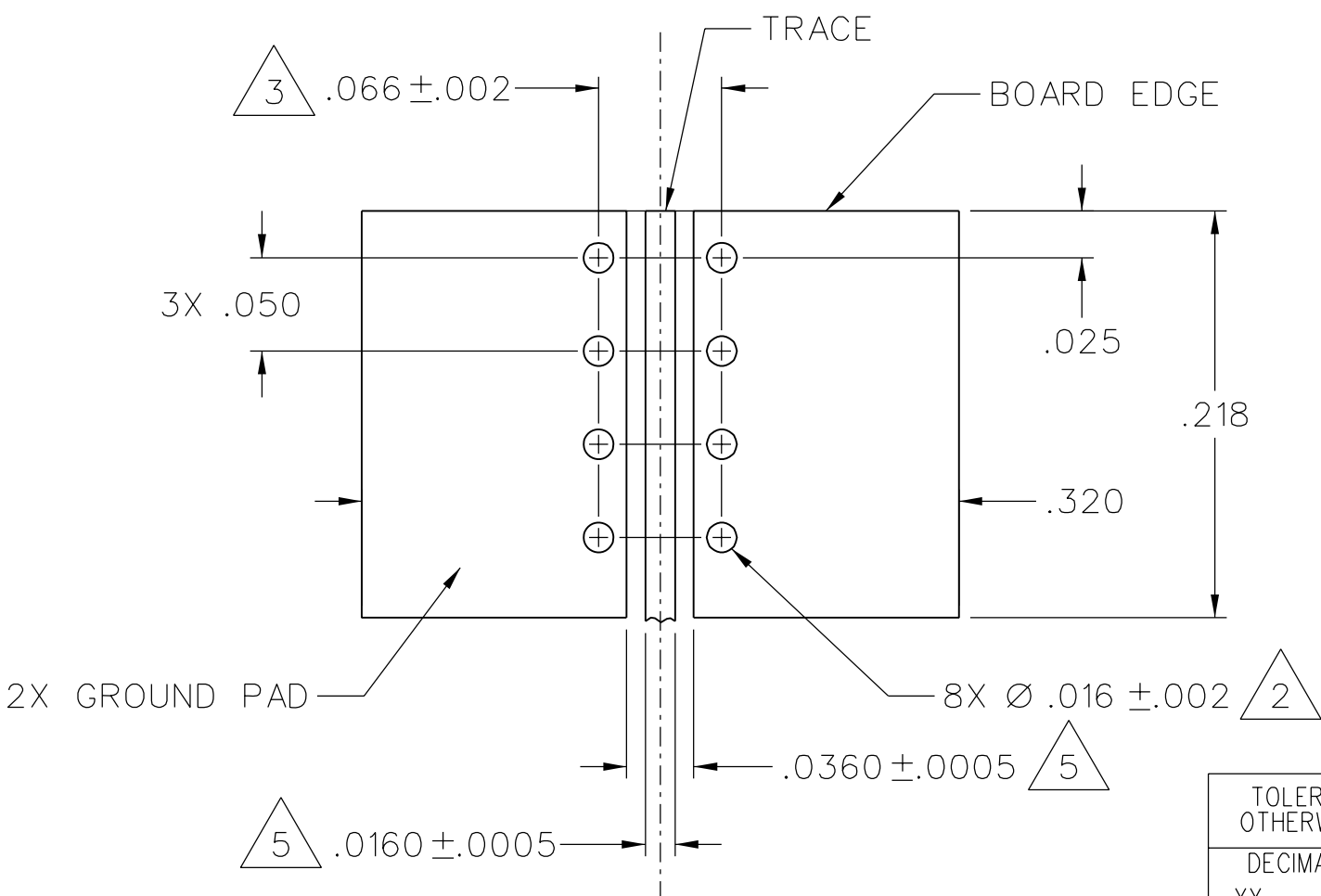
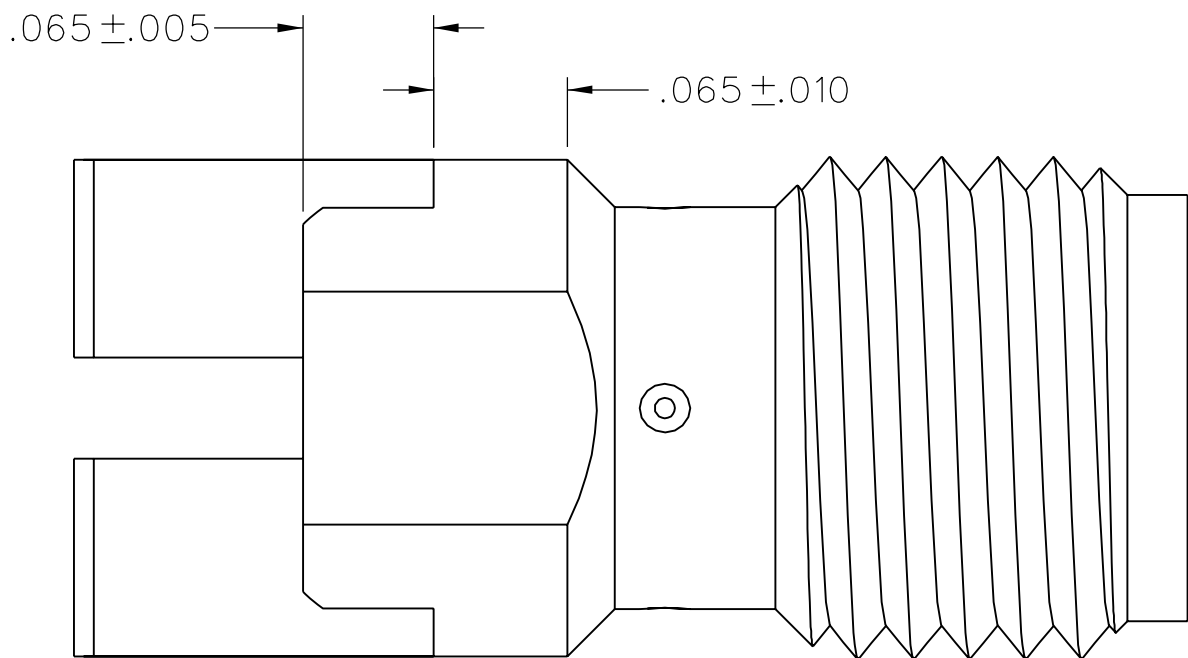
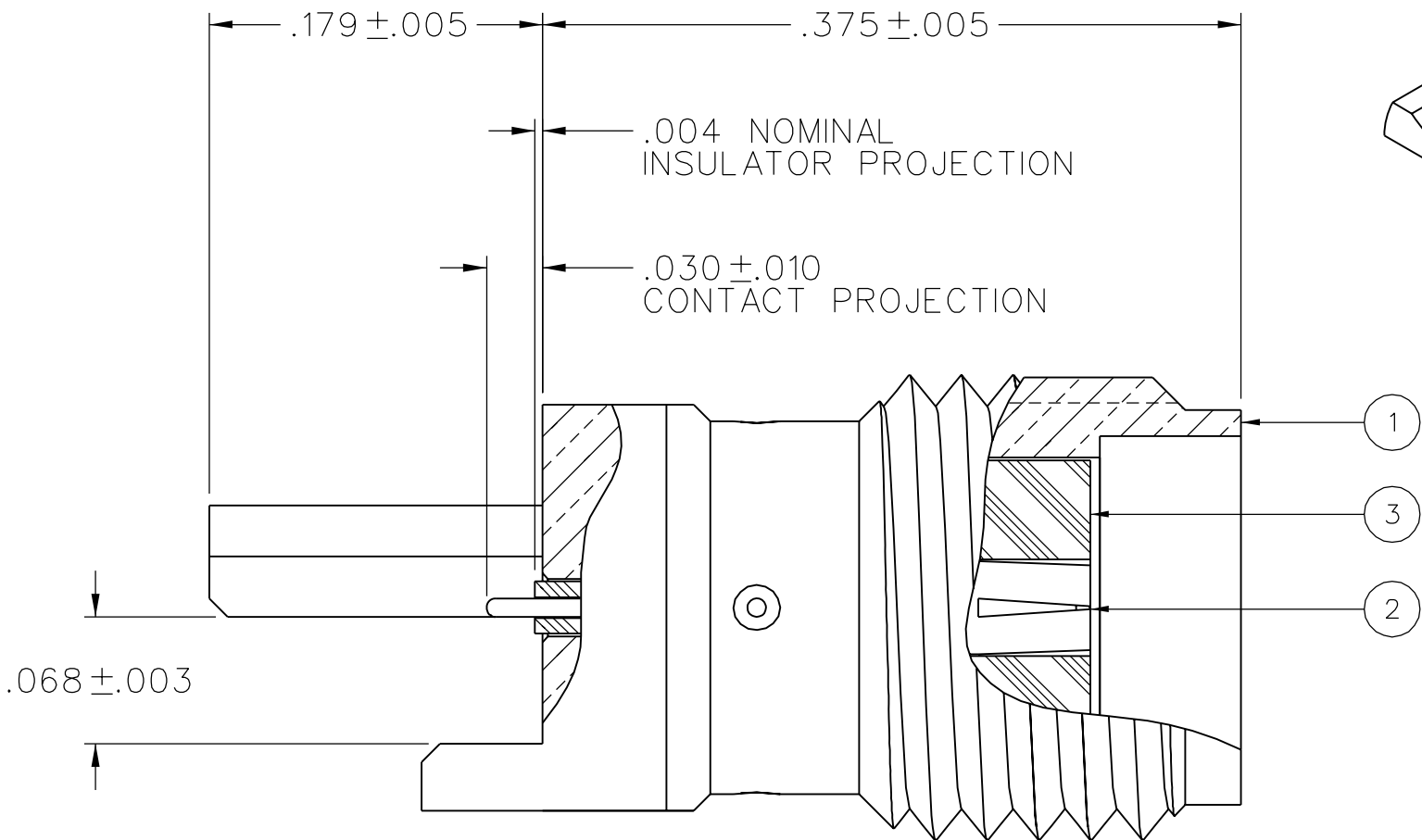
2. ALL HOLES PLATED THRU ENTIRE CIRCUIT BOARD STACKUP.

3. HOLE PATTERNS SYMMETRICAL ABOUT CENTER OF CPW TRACE.

4. FOR OPTIMUM CIRCUIT BOARD HIGH FREQUENCY PERFORMANCE:
- A. MAINTAIN SOLID GROUND PLANE BELOW HF SUBSTRATE.
 - B. CONTROL PULLBACK OF TRACE AND GROUNDS FROM BOARD EDGE.
 - C. CONTINUE GROUNDED COPLANAR LINE BEYOND GROUND PADS.
 - D. PLACE 16 MIL DIA GROUND VIAS ON BOTH SIDES OF COPLANAR WAVEGUIDE LINE AT 50 MIL INTERVALS ALONG ENTIRE LENGTH.
 - E. IMMERSION GOLD PLATE (ENIG) ALL CONDUCTORS PER IPC-4552.

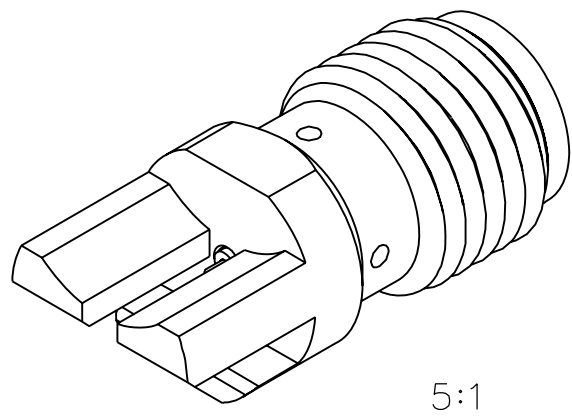
5. REFERENCE DIMENSIONS FOR 50 OHM GROUNDED CPW LINE, USING ROGERS R04003, 8 MIL HIGH FREQUENCY CIRCUIT BOARD SUBSTRATE:
TRACE WIDTH = 16 MILS
GROUND GAPS = 10 MILS
CONDUCTOR THICKNESS = 1 MIL (INCLUDES PLATING)

6. EMERSON NETWORK POWER CONNECTIVITY SOLUTIONS HIGH FREQUENCY END LAUNCH CONNECTORS ARE COVERED UNDER US PATENT NUMBER 7,344,381



MOUNTING FOOTPRINT

10:1 (TOP VIEW, INCLUDING TRACE DIMENSIONS)



DRAWING NO.									
C - 142-0761-891/899									
0	REVISIONS								
ENGINEERING RELEASE									
1	8-16-04	J	R	K				9-10-04	ECN 49415
ADDED NOTE: 6									

* REVISION NUMBER FOLLOWED BY AN ALPHA *									
* CHARACTER INDICATES DRAWING CLARIFI- *									
* CATION OR PART NUMBER ADDITION ONLY. *									

1a	4-14-08	P	J	M	B			5-7-08	ECN 51484
		A	R	J	L				

CUSTOMER DRAWING

THIS DRAWING TO BE INTERPRETED
PER ASME Y 14.5M - 1994

"μSTATION"

COMPANY CONFIDENTIAL

TOLERANCE UNLESS OTHERWISE SPECIFIED		DRAWN BY	DATE	Connectivity Solutions	
DECIMALS	mm	JRK	8-16-04	EMERSON Network Power	P.O. Box 1732 Waseca, MN 56093 1-800-247-8256
.XX	_____	CHECKED BY	DATE		
.XXX ±.003	_____	APPROVED BY	DATE	TITLE HIGH FREQ END LAUNCH SMA JACK ASSEMBLY, EDGE MOUNT, 10 MIL PIN	
MATL	_____	JRK	9-10-04		
FINISH	_____	RELEASE DATE	9-10-04	SHEET 2 OF 2	DRAWING NO. C - 142-0761-891/899
		U/M INCH	SCALE 10:1		